

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: B. CHANDRAN ET AL.

Filed: December 21, 2001

For: CHIP-JOIN PROCESS TO REDUCE ELONGATION MISMATCH
BETWEEN THE ADHERENTS AND SEMICONDUCTOR
PACKAGE MADE THEREBY

**PETITION FOR ACCEPTANCE
OF PHOTOGRAPHS UNDER 37 CFR 1.84 (b)**

Assistant Commissioner for Patents
Washington, D.C. 20231

December 21, 2001

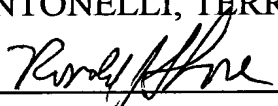
Sir:

In the matter of the above-identified application, Applicants hereby petition for acceptance of the attached photographs for Figures 3A-3E.

This petition is accompanied by a Credit Card Payment Form to cover the fee of \$130.00 set forth in 37 CFR 1.17(h) and two additional sets of photographs, as required by 37 CFR 1.84(b).

Please charge any shortage in the fees due in connection with the filing of this paper to Deposit Account No. 01-2135 (219.40779X00) and please credit any excess fees to such deposit account.

Respectfully submitted,
ANTONELLI, TERRY, STOUT & KRAUS, LLP



Ronald J. Shore
Registration No. 28,577

RJS:alw
(703) 312-6600